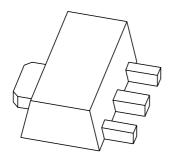
### **DISCRETE SEMICONDUCTORS**

# DATA SHEET



# PXT4401 NPN switching transistor

Product data sheet Supersedes data of 1999 Apr 14 2004 Nov 22



## **NPN** switching transistor

**PXT4401** 

### **FEATURES**

- High current (max. 600 mA)
- Low voltage (max. 40 V).

### **APPLICATIONS**

 Switching and linear amplification in industrial and consumer applications.

### **DESCRIPTION**

NPN switching transistor in a SOT89 plastic package. PNP complement: PXT4403.

### **MARKING**

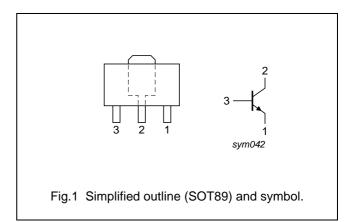
| TYPE NUMBER | MARKING CODE(1) |
|-------------|-----------------|
| PXT4401     | *2X             |

### Note

- 1. \* = p: Made in Hong Kong.
  - \* = t: Made in Malaysia.
  - \* = W: Made in China.

### **PINNING**

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | emitter     |
| 2   | collector   |
| 3   | base        |



### **ORDERING INFORMATION**

| TYPE NUMBER | PACKAGE          |  |       |  |
|-------------|------------------|--|-------|--|
| TIFE NOMBER | NAME DESCRIPTION |  |       |  |
| PXT4401     | SC-62            | plastic surface mounted package; collector pad for good heat transfer; 3 leads | SOT89 |  |

PXT4401

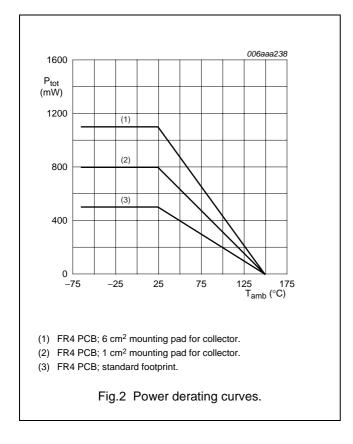
### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL           | PARAMETER                 | CONDITIONS               | MIN. | MAX. | UNIT |
|------------------|---------------------------|--------------------------|------|------|------|
| V <sub>CBO</sub> | collector-base voltage    | open emitter             | _    | 60   | V    |
| V <sub>CEO</sub> | collector-emitter voltage | open base                | _    | 40   | V    |
| V <sub>EBO</sub> | emitter-base voltage      | open collector           | _    | 5    | V    |
| I <sub>C</sub>   | collector current (DC)    |                          | _    | 600  | mA   |
| I <sub>CM</sub>  | peak collector current    |                          | -    | 800  | mA   |
| I <sub>BM</sub>  | peak base current         |                          | _    | 200  | mA   |
| P <sub>tot</sub> | total power dissipation   | T <sub>amb</sub> ≤ 25 °C |      |      |      |
|                  |                           | note 1                   | _    | 0.5  | W    |
|                  |                           | note 2                   | _    | 0.8  | W    |
|                  |                           | note 3                   | _    | 1.1  | W    |
| T <sub>stg</sub> | storage temperature       |                          | -65  | +150 | °C   |
| Tj               | junction temperature      |                          | -    | 150  | °C   |
| T <sub>amb</sub> | ambient temperature       |                          | -65  | +150 | °C   |

### **Notes**

- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm<sup>2</sup>.



# NPN switching transistor

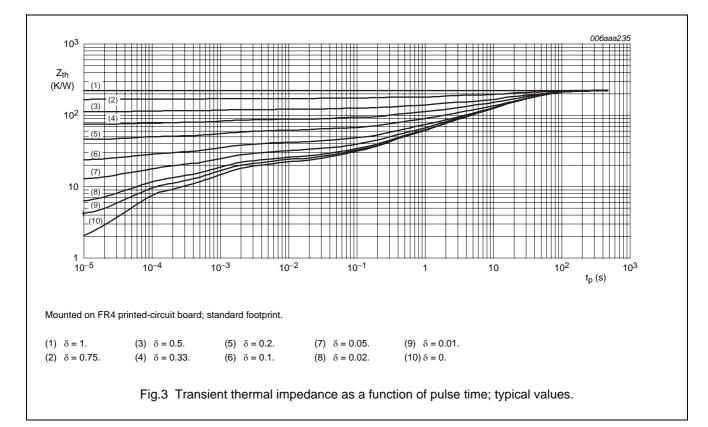
PXT4401

### THERMAL CHARACTERISTICS

| SYMBOL               | PARAMETER   | CONDITIONS  | VALUE | UNIT |
|----------------------|---|-------------|-------|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to                 | in free air |       |      |
|                      | ambient   | note 1      | 250   | K/W  |
|                      |   | note 2      | 156   | K/W  |
|                      |   | note 3      | 113   | K/W  |
| R <sub>th(j-s)</sub> | thermal resistance from junction to soldering point |             | 30    | K/W  |

### **Notes**

- 1. Device mounted on a printed-circuit board, single-sided copper, tin-plated and standard footprint.
- 2. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a printed-circuit board, single-sided copper, tin-plated and mounting pad for collector 6 cm<sup>2</sup>.



PXT4401

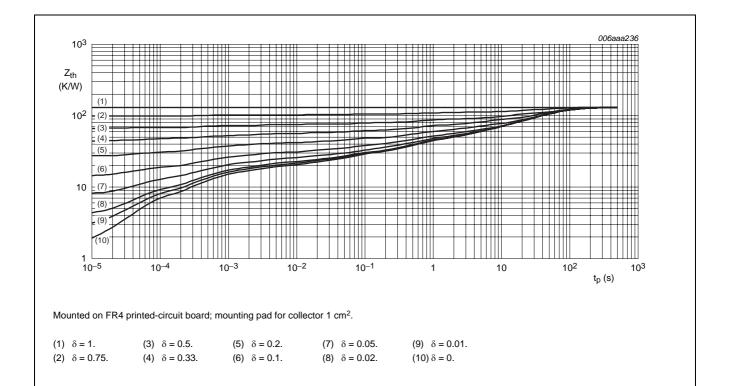


Fig.4 Transient thermal impedance as a function of pulse time; typical values.

006aaa237 10<sup>3</sup>  $Z_{th}$ (K/W) 10<sup>2</sup> (5) 10 [7] 1 — 10<sup>-5</sup> 10-4 10-3 10-2 10<sup>-1</sup> 10<sup>2</sup> 10<sup>3</sup> 10 t<sub>p</sub> (s) Mounted on FR4 printed-circuit board; mounting pad for collector 6 cm<sup>2</sup>.

(7)  $\delta = 0.05$ .

(8)  $\delta = 0.02$ .

Fig.5 Transient thermal impedance as a function of pulse time; typical values.

(9)  $\delta = 0.01$ .

(10)  $\delta = 0$ .

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(5)  $\delta = 0.2$ .

(6)  $\delta = 0.1$ .

(3)  $\delta = 0.5$ .

(4)  $\delta = 0.33$ .

(1)  $\delta = 1$ .

(2)  $\delta = 0.75$ .

# NPN switching transistor

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### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

| SYMBOL  | PARAMETER   | CONDITIONS  | MIN. | MAX. | UNIT |
|---|---|---|------|------|------|
| I <sub>CBO</sub>  | collector-base cut-off current                          | I <sub>E</sub> = 0 A; V <sub>CB</sub> = 60 V                                | _    | 50   | nA   |
| I <sub>EBO</sub>  | emitter-base cut-off current                            | I <sub>C</sub> = 0 A; V <sub>EB</sub> = 6 V                                 | _    | 50   | nA   |
| h <sub>FE</sub>   | DC current gain   | V <sub>CE</sub> = 1 V; (see Fig.6)  | 20   | _    |      |
|   |   | I <sub>C</sub> = 0.1 mA   | 20   | _    |      |
|   |   | I <sub>C</sub> = 1 mA   | 40   | _    |      |
|   |   | I <sub>C</sub> = 10 mA  | 80   | _    |      |
|   |   | I <sub>C</sub> = 150 mA; note 1   | 100  | 300  |      |
|   |   | I <sub>C</sub> = 500 mA; V <sub>CE</sub> = 2 V; note 1                      | 40   | _    |      |
| V <sub>CEsat</sub>  | collector-emitter saturation                            | I <sub>C</sub> = 150 mA; I <sub>B</sub> = 15 mA; note 1                     | _    | 400  | mV   |
| voltage   | I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1 | _   | 750  | mV   |      |
| V <sub>BEsat</sub>  | base-emitter saturation voltage                         | I <sub>C</sub> = 150 mA; I <sub>B</sub> = 15 mA; note 1                     | _    | 950  | mV   |
|   |   | $I_C = 500 \text{ mA}$ ; $I_B = 50 \text{ mA}$ ; note 1                     | _    | 1.2  | V    |
| C <sub>c</sub>  | collector capacitance                                   | $I_E = i_e = 0 \text{ A}; V_{CB} = 5 \text{ V}; f = 1 \text{ MHz}$          | _    | 8    | pF   |
| C <sub>e</sub>  | emitter capacitance                                     | $I_C = i_c = 0 \text{ A}$ ; $V_{EB} = 500 \text{ mV}$ ; $f = 1 \text{ MHz}$ | _    | 30   | pF   |
| f <sub>T</sub>  | transition frequency                                    | $I_C = 20 \text{ mA}; V_{CE} = 10 \text{ V}; f = 100 \text{ MHz}$           | 250  | _    | MHz  |
| Switching times (between 10% and 90% levels); (see Fig.7) |   |   |      |      |      |
| t <sub>on</sub>   | turn-on time  | I <sub>Con</sub> = 150 mA; I <sub>Bon</sub> = 15 mA;                        | _    | 35   | ns   |
| t <sub>d</sub>  | delay time  | I <sub>Boff</sub> = -15 mA  | _    | 15   | ns   |
| t <sub>r</sub>  | rise time   |   | _    | 20   | ns   |
| t <sub>off</sub>  | turn-off time   |   | _    | 250  | ns   |
| t <sub>s</sub>  | storage time  |   | _    | 200  | ns   |
| t <sub>f</sub>  | fall time   |   | _    | 60   | ns   |

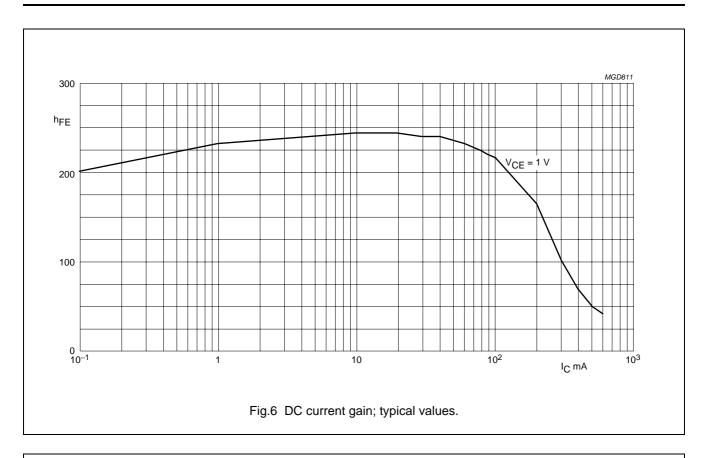
### Note

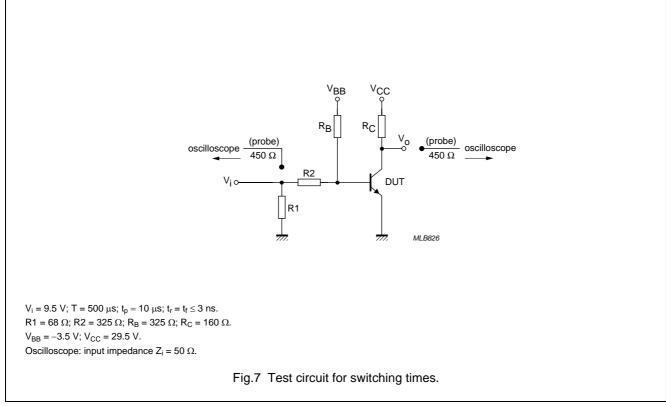
1. Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 

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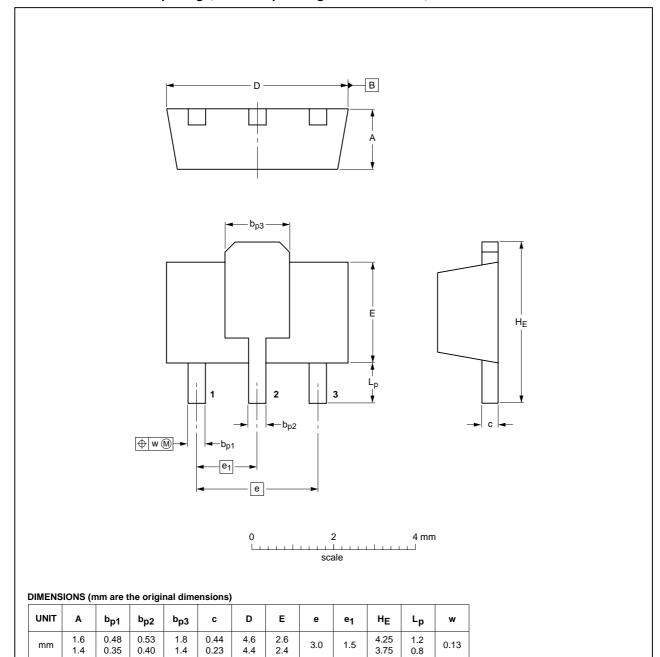
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### **PACKAGE OUTLINE**

### Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



| OUTLINE | REFERENCES |        | EUROPEAN | IOOUE DATE |            |                                   |
|---------|------------|--------|----------|------------|------------|-----------------------------------|
| VERSION | IEC        | JEDEC  | JEITA    |            | PROJECTION | ISSUE DATE                        |
| SOT89   |            | TO-243 | SC-62    |            |            | <del>-04-08-03-</del><br>06-03-16 |

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### NPN switching transistor

PXT4401

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|-----------------------------------|----------------------------------|---|
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| Preliminary data sheet            | Qualification                    | This document contains data from the preliminary specification.                       |
| Product data sheet                | Production                       | This document contains the product specification.                                     |

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